APPLICA	BLE STAN	DARD							
RATING	OPERATING	PE DANGE	-30°C TO + 85°C(N	NOTE 1)	STORAGE	URE RANGE	-10°C TO + 60°C	(NOTE	2)
	TEMPERATURE RANGE OPERATING				STORAGE				
	HUMIDITY RANGE		40% TO + 80%	⁶ 0	HUMIDITY F		40% TO + 70% (N	IUIE 2,)
	VOLTAGE		AC 250V	0.4	VOLTAGE		AC 30V	0.1	
	CURRENT		AWG 22 TO 26 : 2A		CURRENT	RRENT AWG 22 :		2A 1A	
			AWG 28 : 1A AWG 30 : 0.5A				AWG 24 TO 28 : AWG 30 : 0.5		
					TIONS		Alia 50 . C	. JA	
		T		IFICA	110113				
	EM		TEST METHOD			REC	UIREMENTS	QT	AT
	RUCTION	IVICUALLY	AND BY MEASURING INSTRU	MENT	IACCC	DDING TO F	DRAWING.	ΤX	Tv
		VISUALLY AND BY MEASURING INSTRUMENT. CONFIRMED VISUALLY.				ACCORDING TO DRAWING.			X
								Х	1^
CONTACT RE	IC CHARA				30 m	O MAY		X	т —
		100 mA (DC OR 1000 Hz).				30 mΩ MAX.			+
INSULATION RESISTANCE						1,555,1,1,1,1,1,1,1,1,1,1,1,1,1,1,1,1,1			
			50 V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.			-
			ERISTICS						
MECHANICAL OPERATION 3/		30 TIME	30 TIMES INSERTIONS AND EXTRACTIONS.			① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.			② NC	NO ELECTRICAL DISCONTINUITY OF 1µs. NO DAMAGE, CRACK OR LOOSENESS OF			-
FO		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			S PA	RTS.		Х	_
ENVIRO	NMENTAL		ACTERISTICS						
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 \rightarrow 5 TO 35 \rightarrow +85 \rightarrow 5 TO 35 °C TIME 30 \rightarrow 5 TO 15 \rightarrow 30 \rightarrow 5 TO15 min UNDER 5 CYCLES.			nin ② INS ③ NO	CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 1000MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			② INS ③ NO	 ↑ CONTACT RESISTANCE: 30mΩ MAX. ⊘ INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 			-
RESISTANCE TO 1) SOLDERING HEAT		1) AUTOMATIC SOLDERING (REFLOW) 《REFLOW AREA》 MAX 240°C WITHIN 10 sec. MIN 220°C WITHIN 60sec. 《PREHEATING AREA》			NO DE	FORMATION	OF CASE OF EXCESSIVE HE TERMINALS.	X	_
SOLDERABII	ITV	TWICE AND H TEMPE SECON 2) MANUA SOLDE SOLDE NO STI	180° 90 TO 120 sec. ROUGH IN REFROW FURNACE. FEAVE IN AMBIENT TEMPER UMIDITY FOR 1 HOUR, CONNE ERATURE TO BE AMBIENT FO ND REFLOW. L SOLDERING ERING IRON TEMPERATURE :2 ERING TIME :3s. RENGTH ON CONTACT. ED AT SOLDER TEMPERATURE	RATURE EVCTOR R 190±10°C,	A NITIA	UNIFORM CO	DATING OF SOLDER SHALL		
			FOR IN IMMERSION , DURATION, 3 s.			COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.			_
COUN	T DI	ESCRIPTION	ON OF REVISIONS		DESIGNED		CHECKED	D/	ATE
1		DIS	DIS-H-001311		AK.MIURA		1		09.08
REMARKS NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.						APPROVE			
NOTE 2:APPLY	TO THE CONDI	TION OF LO	NG TERM STORAGE FOR UNUSED PRODUCTS			CHECKED		05.02.0	
			R PCB BOARD , OPERATING TEMPERATURE AND RINTERM STORAGE DURING TRANSPORTATION.			DESIGNED	D IO.DENPOUYA	05.0	01.28
	se specifid , refe					DRAWN	FK.MATSUKI	05.0	01.24
Jnless otherwi						RAWING NO. ELC4-306016-			
	ualification Tes	st AT:Ass	urance Test X:Applicable Te	st	DRAWI	NG NO.	ELC4-30601	6-01	
			urance Test X:Applicable Te		DRAWI PART NO.		DF11GZ-*DP-2V (20		